SCBS227J - JULY 1993 - REVISED AUGUST 2003

- Member of the Texas Instruments Widebus™ Family
- Supports the VME64 ETL Specification
- Reduced TTL-Compatible Input Threshold Range
- High-Drive Outputs (I<sub>OH</sub> = -60 mA, I<sub>OL</sub> = 90 mA) Support Equivalent 25-Ω Incident-Wave Switching
- V<sub>CC</sub>BIAS Pin Minimizes Signal Distortion During Live Insertion
- Internal Pullup Resistor on OE Keeps
   Outputs in High-Impedance State During
   Power Up or Power Down
- Distributed V<sub>CC</sub> and GND Pins Minimize High-Speed Switching Noise
- Equivalent 25-Ω Series Damping Resistor on B Port
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors

#### description/ordering information

The SN74ABTE16246 is an 11-bit noninverting transceiver designed for asynchronous two-way communication between buses. This device has open-collector and 3-state outputs. The device

allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable ( $\overline{OE}$ ) input can be used to disable the device so that the buses are effectively isolated. When  $\overline{OE}$  is low, the device is active.

The B port has an equivalent  $25-\Omega$  series output resistor to reduce ringing. Active bus-hold inputs on the B port hold unused or floating inputs at a valid logic level.

The A port provides for the precharging of the outputs via  $V_{CC}BIAS$ , which establishes a voltage between 1.3 V and 1.7 V when  $V_{CC}$  is not connected.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

#### ORDERING INFORMATION

TA	PACKA	\GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
−40°C to 85°C	SSOP – DL	Tube	SN74ABTE16246DL	ABTE16246
	330F - DL	Tape and reel	SN74ABTE16246DLR	ABTE 10240
	TSSOP – DGG	Tape and reel	SN74ABTE16246DGGR	ABTE16246

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design quidelines are available at www.ti.com/sc/package.



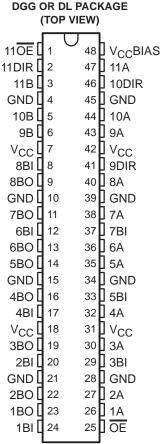
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PRODUCTION DATA information is current as of publication date.
Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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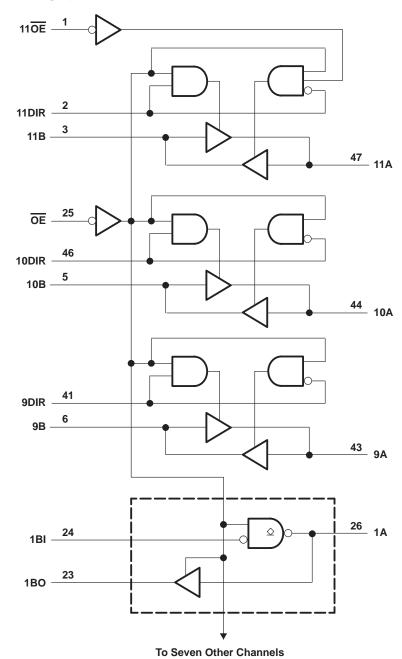
#### **SN74ABTE16246** 11-BIT INCIDENT-WAVE SWITCHING BUS TRANSCEIVER WITH 3-STATE AND OPEN-COLLECTOR OUTPUTS SCBS227J – JULY 1993 – REVISED AUGUST 2003

#### **FUNCTION TABLE**

		INPUTS			OPERATION
OE	9DIR	10DIR	11DIR	110E	OPERATION
Н	Х	Х	Х	Х	Isolation
L	Χ	Х	Х	Χ	1BI–8BI data to 1A–8A bus (OC <sup>†</sup> ), 1A–8A data to 1BO–8BO bus
L	L	Х	Х	Х	9A data to 9B bus
L	Н	X	X	X	9B data to 9A bus
L	X	L	Χ	X	10A data to 10B bus
L	X	Н	Χ	X	10B data to 10A bus
L	X	X	L	L	11A data to 11B bus
L	X	X	L	Н	11A, 11B isolation
L	Χ	X	Н	Χ	11B data to 11A bus

<sup>†</sup>OC = Open-collector outputs

#### logic diagram (positive logic)





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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub> and V <sub>CC</sub> BIAS	0.5	V to 7 V
Input voltage range, V <sub>I</sub> (except I/O ports) (see Note 1)	0.5	V to 7 V
Voltage range applied to any output in the high or power-off state, VO	0.5 V	' to 5.5 V
Current into any output in the low state, IO		128 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)		-18 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)		-50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package		70°C/W
DL package		63°C/W
Storage temperature range, T <sub>sto</sub>	. −65°C	to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions (see Note 3)

			MIN	NOM	MAX	UNIT	
V <sub>CC</sub> , V <sub>CC</sub> BIAS	Supply voltage	Supply voltage				V	
V	High level input veltege	ŌĒ	2			V	
VIH	High-level input voltage Except $\overline{\text{OE}}$		1.6			V	
V <sub>IL</sub>	Law lavel input valtage	ŌĒ		V			
	Low-level input voltage Except OE				1.4	V	
Vон	High-level output voltage	1A-8A	0		5.5	V	
٧ <sub>I</sub>	Input voltage	-	0		Vcc	V	
la	Lligh level output ourrest	B bus			-12	A	
IOH	High-level output current	9A-11A			-64	mA	
1	Lavida valavita vima at	B bus			12	Δ	
lOL	Low-level output current A bus				90	mA	
Δt/Δν	Input transition rise or fall rate	Outputs enabled			10	ns/V	
T <sub>A</sub>	Operating free-air temperature	-	-40		85	°C	

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

#### **SN74ABTE16246** 11-BIT INCIDENT-WAVE SWITCHING BUS TRANSCEIVER WITH 3-STATE AND OPEN-COLLECTOR OUTPUTS SCBS227J – JULY 1993 – REVISED AUGUST 2003

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	ONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
VIK		V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = -18 mA			-1.2	V
		V <sub>CC</sub> = 5.5 V,	I <sub>OH</sub> = -100 μA			V <sub>CC</sub> -0.2	
	B port	V <sub>CC</sub> = 4.5 V	$I_{OH} = -1 \text{ mA}$	2.4			
Va		VCC = 4.5 V	$I_{OH} = -12 \text{ mA}$	2			V
VOH		V <sub>CC</sub> = 5.5 V,	I <sub>OH</sub> = -1 mA			4.5	V
	9A-11A	V <sub>CC</sub> = 4.5 V	$I_{OH} = -32 \text{ mA}$	2.4			
		VCC = 4.5 V	$I_{OH} = -64 \text{ mA}$	2			
IOH	1A-8A	$V_{CC} = 4.5 \text{ V},$	V <sub>OH</sub> = 5.5 V			20	μΑ
	B port	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 1 mA			0.4	
\/o:	Вроп	VCC = 4.5 V	$I_{OL} = 12 \text{ mA}$			0.8	V
VOL	A port	V <sub>CC</sub> = 4.5 V	$I_{OL} = 64 \text{ mA}$			0.55	v
	A port	VCC = 4.5 V	$I_{OL} = 90 \text{ mA}$				
V <sub>hys</sub>					100		mV
		V 45V	V <sub>I</sub> = 0.8 V	100			
I <sub>I(hold)</sub>	B port	V <sub>CC</sub> = 4.5 V	V <sub>I</sub> = 2 V	-100			μΑ
		V <sub>CC</sub> = 5.5 V,	$V_{I} = 0 \text{ to } 5.5 \text{ V}$			±500	
1.	Control inputs	V <sub>CC</sub> = 5.5 V	Vi – Voo or CND			±1	
=	A or B ports	$V_{CC} = 5.5 \text{ V}, \overline{OE} = V_{CC}$	V <sub>I</sub> = V <sub>CC</sub> or GND			±20	μΑ
<sup>I</sup> OZH <sup>‡</sup>	9A-11A	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.7 V			10	μΑ
lozL <sup>‡</sup>	9A-11A	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 0.5 V			-10	μΑ
lo.	A port	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.5 V	-50		-180	mA
Ю	B port	VCC = 5.5 V,	V() = 2.5 V	-25		-90	IIIA
l <sub>off</sub>		$V_{CC} = 0$ , $V_I$ or $V_O \le 4.5$ V,	V <sub>CC</sub> BIAS = 0			±100	μΑ
			Outputs high		28	36	
ICC	A or B ports	$V_{CC} = 5.5 \text{ V}, I_{O} = 0,$ $V_{I} = V_{CC} \text{ or GND}$	Outputs low		38	48	mA
		17 166 91 9115	Outputs disabled		20	32	
loop	A or B ports	V <sub>CC</sub> = 5 V, C <sub>L</sub> = 50 pF	OE high		0.02		mA/
ICCD	A of D ports	VCC = 3 V, OL = 30 рг	OE low		0.33		MHz
Ci	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V			2.5	4	pF
C <sub>io</sub>	I/O ports	$V_0 = 2.5 \text{ V or } 0.5 \text{ V}$			4.5	8	pF

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. ‡ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

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#### live-insertion specifications over recommended operating free-air temperature range

PA	RAMETER		MIN	TYP <sup>†</sup>	MAX	UNIT				
ICC (VCCBIAS)		$V_{CC} = 0 \text{ to } 4.5 \text{ V},$	$V_{CC}BIAS = 4.5 V \text{ to } 5.5 V,$	$I_{O(DC)} = 0$		250	700	μA		
ICC (v	CCRIV2)	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}^{\ddagger},$	$V_{CC}BIAS = 4.5 V \text{ to } 5.5 V,$	$I_{O(DC)} = 0$			20	μΑ		
\/-	V- A port V 0		$V_{CC}BIAS = 4.5 V \text{ to } 5.5 V$		1.1	1.5	1.9	V		
Vo	A port	VCC = 0	V <sub>CC</sub> BIAS = 4.75 V to 5.25 V		1.3	1.5	1.7	V		
lo.	In Aport Ven O		V00PIAS - 4.5.V	V <sub>O</sub> = 0	-20		-100			
10	IO A port	A port $V_{CC} = 0$ ,		V <sub>CC</sub> BIAS = 4.5 V	V <sub>O</sub> = 3 V	20		100	μΑ	

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

### switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L$ = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)		CC = 5 V A = 25°C		MIN	MAX	UNIT
	(1141 01)	(0011 01)	MIN	TYP	MAX			
tPLH	А	В	1.5	3.1	4.2	1.5	5.2	ns
<sup>t</sup> PHL	A	В	1.5	3.5	4.6	1.5	5.2	115
<sup>t</sup> PLH	9B–11B	9A–11A	1.5	3	3.8	1.5	4.5	ns
<sup>t</sup> PHL	90-110	9A-11A	1.5	3.2	4	1.5	4.5	115
t <sub>PLH</sub> §			1.5	3.2	4	1.5	4.5	
t <sub>PLH</sub> ¶	1B–8B	1A-8A	7.5	8.9	9.7	7.5	10.3	ns
t <sub>PHL</sub>			1.5	3.2	4	1.5	4.5	
<sup>t</sup> PZH	ŌĒ	9A–11A	2	4.3	5.3	2	6.2	ns
<sup>t</sup> PZL	OE	1A-11A	2	4.4	5.4	2	6.8	115
<sup>t</sup> PZH	ŌĒ	В	2	4.3	6	2	7.1	ns
tPZL	OE	В	2	4.5	6.4	2	7.3	115
<sup>t</sup> PHZ	ŌĒ	9A–11A	2	4.2	5.9	2	6.7	ns
t <sub>PLZ</sub>	OE	1A-11A	2	3.5	4.6	2	5.1	115
<sup>t</sup> PHZ	ŌĒ	В	2.5	4.3	6.2	2.5	7	ns
<sup>t</sup> PLZ	ÇL .		2	3.6	5	2	5.5	115

 $<sup>\</sup>frac{9}{2}$  Measurement point is V<sub>OL</sub> + 0.3 V.



<sup>‡</sup> VCC - 0.5 V < VCCBIAS

<sup>¶</sup> Measurement point is  $V_{OL}$  + 1.5 V.

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#### extended switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD		V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			MAX	UNIT
	(1141 01)	(0011 01)		MIN	TYP	MAX			
<sup>t</sup> PLH	9B–11B	9A-11A R <sub>X</sub> = 13 S	Pv = 13 O	1.5	3.2	4	1.5	4.8	ns
t <sub>PHL</sub>	96-116		KX = 13 22	1.5	3.8	4.7	1.5	5.6	115
tPHL	1B-8B	1A-8A	Rχ = 13 Ω	1.5	3.3	4.2	1.5	4.8	ns
t <sub>PLH</sub>	0D 44D	9A-11A	Dv. 26.0	1.5	3.1	4	1.5	4.6	
tPHL	9B–11B	9A-11A	Rχ = 26 Ω	1.5	3.5	4.4	1.5	4.9	ns
t <sub>PHL</sub>	1B–8B	1A-8A	Rχ = 26 Ω	1.5	3.1	4	1.5	4.4	ns
tPLH	0D 44D	1A–8A R <sub>X</sub> = 56	D	1.5	3	3.8	1.5	4.5	
t <sub>PHL</sub>	9B–11B		$11\chi = 30.22$	1.5	3.3	4.2	1.5	4.7	ns
tPHL	1B–8B	1A-8A	Rχ = 56 Ω	1.5	3	4	1.5	4.4	ns
	В	А	R <sub>X</sub> = Open		0.1	0.6		2	
t <sub>sk(p)</sub>	А	В	R <sub>X</sub> = Open		0.4	0.8		2	ns
,	В	А	Rχ = 26 Ω		0.3	0.8		2	
	В	А	R <sub>X</sub> = Open		0.3	0.7		1.3	
t <sub>sk(o)</sub>	А	В	R <sub>X</sub> = Open		0.7	1.1		1.3	ns
	В	А	Rχ = 26 Ω		0.5	1		1.3	
t <sub>t</sub> †	В	Α	Rχ = 26 Ω	0.5	0.8	1.5	0.5	1.5	ns
t <sub>t</sub> ‡	А	В	R <sub>X</sub> = Open	3.5	5.5	7.3	3.5	7.9	ns

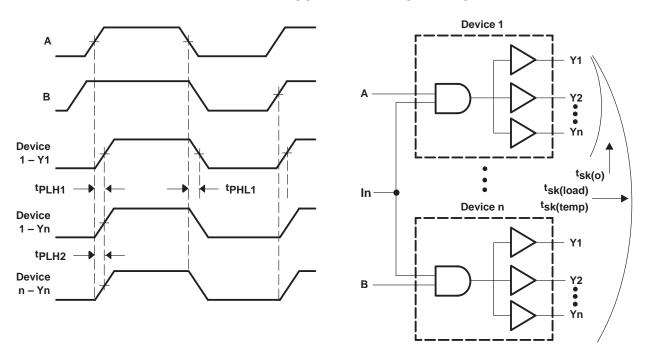
## extended output characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L$ = 50 pF (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	LOAD	MIN MA	X UNIT
	A B $V_{CC} = constant$ ,			2	.5	
<sup>t</sup> sk(temp)	В	Α	$\Delta T_A = 20^{\circ}C$	$R_X = 56 \Omega$		4 ns
<sup>t</sup> sk(load)	В	А	V <sub>CC</sub> = constant, Temperature = constant	$R_X = 13, 26, \text{ or } 56 \Omega$		4 ns

 $<sup>^\</sup>dagger$   $t_t$  is measured between 1 V and 2 V of the output waveform.  $^\ddagger$   $t_t$  is measured between 10% and 90% of the output waveform.

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#### PARAMETER MEASUREMENT INFORMATION



- NOTES: A. Pulse skew,  $t_{sk(p)}$ , is defined as the difference in propagation-delay times  $t_{PLH1}$  and  $t_{PHL1}$  on the same terminal at identical operating conditions.
  - B. Output skew,  $t_{sk(0)}$ , is defined as the difference in propagation delay of any two outputs of the same device switching in the same direction (e.g.,  $|t_{PLH1} t_{PLH2}|$ ).
  - C. Temperature skew, t<sub>Sk</sub>(temp), is the output skew of two devices, both having the same value of V<sub>CC</sub> ± 1% and with package temperature differences of 20°C.
  - D. Load skew,  $t_{sk(load)}$ , is measured with  $R_X$  in Figure 2 at 13  $\Omega$  for one unit and 56  $\Omega$  for the other unit.

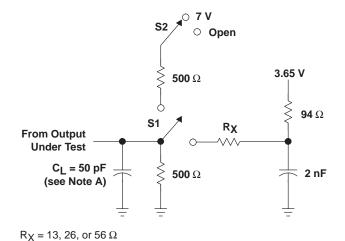
Figure 1. Voltage Waveforms for Extended Characteristics



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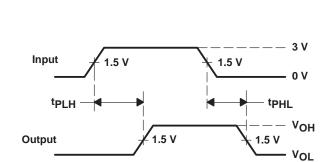
3 V

#### PARAMETER MEASUREMENT INFORMATION



SWITCHING TABLE LOADS	S1	S2
tpLH/tpHL (9A-11A and B port)	Up	Open
tpLH/tpHL (1A-8A)	Up	7 V
tPLZ/tPZL	Up	7 V
t <sub>PHZ</sub> /t <sub>PZH</sub> (except 1A-8A)	Up	Open

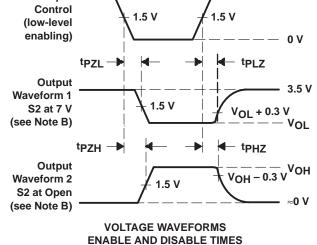
EXTENDED SWITCHING TABLE LOADS	S1	S2
tPLH/tPHL/t <sub>Sk</sub> (A port) tPLH/tPHL/t <sub>Sk</sub> (B port) t <sub>t</sub> (A port) (see Note E) t <sub>t</sub> (B port) (see Note F)	Down Up Down Up	X Open X Open



**VOLTAGE WAVEFORMS** 

**PROPAGATION DELAY TIMES** 

LOAD CIRCUIT



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq 2.5~ns$ ,  $t_f \leq 2.5~ns$ .

Output

- D. The outputs are measured one at a time with one transition per measurement.
- E. t<sub>t</sub> is measured between 1 V and 2 V of the output waveform.
- F. t<sub>t</sub> is measured between 10% and 90% of the output waveform.

Figure 2. Load Circuit and Voltage Waveforms

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#### PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN74ABTE16246DGGR	Active	Production	TSSOP (DGG)   48	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABTE16246
SN74ABTE16246DL	Active	Production	SSOP (DL)   48	25   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABTE16246
SN74ABTE16246DLR	Active	Production	SSOP (DL)   48	1000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABTE16246

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



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#### TAPE AND REEL INFORMATION

# REEL DIMENSIONS Reel Diameter Reel Width (W1)

# TAPE DIMENSIONS KO PI BO W Cavity AO

A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



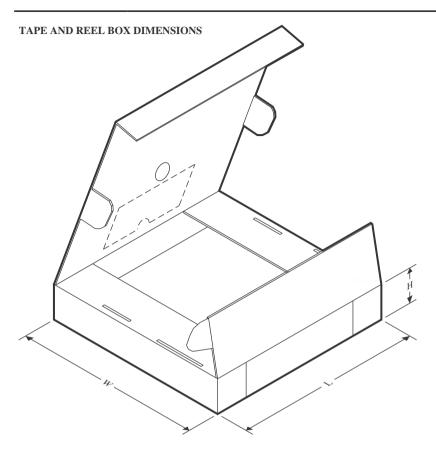
#### \*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABTE16246DGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	13.0	1.8	12.0	24.0	Q1
SN74ABTE16246DLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1



#### **PACKAGE MATERIALS INFORMATION**

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#### \*All dimensions are nominal

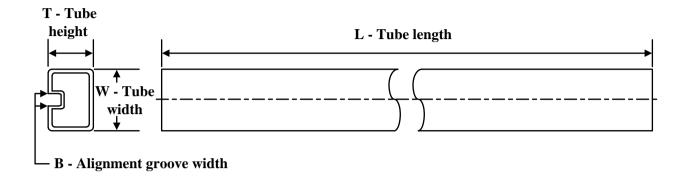
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABTE16246DGGR	TSSOP	DGG	48	2000	367.0	367.0	45.0
SN74ABTE16246DLR	SSOP	DL	48	1000	367.0	367.0	55.0





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#### **TUBE**

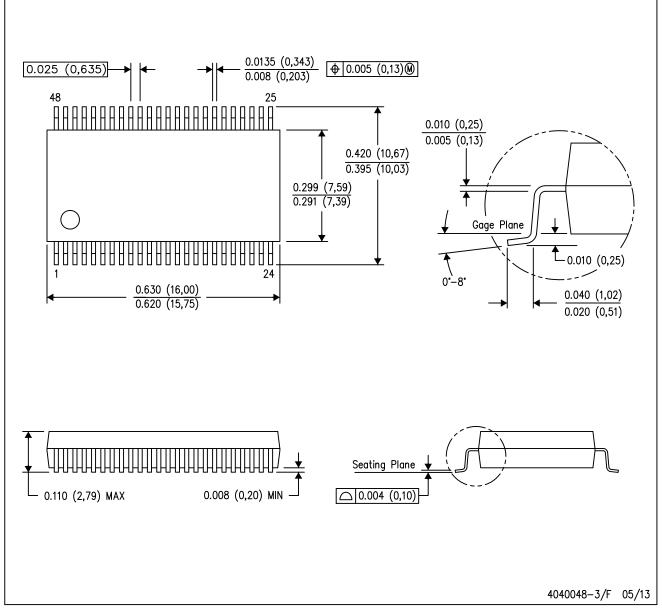


#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74ABTE16246DL	DL	SSOP	48	25	473.7	14.24	5110	7.87

DL (R-PDSO-G48)

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

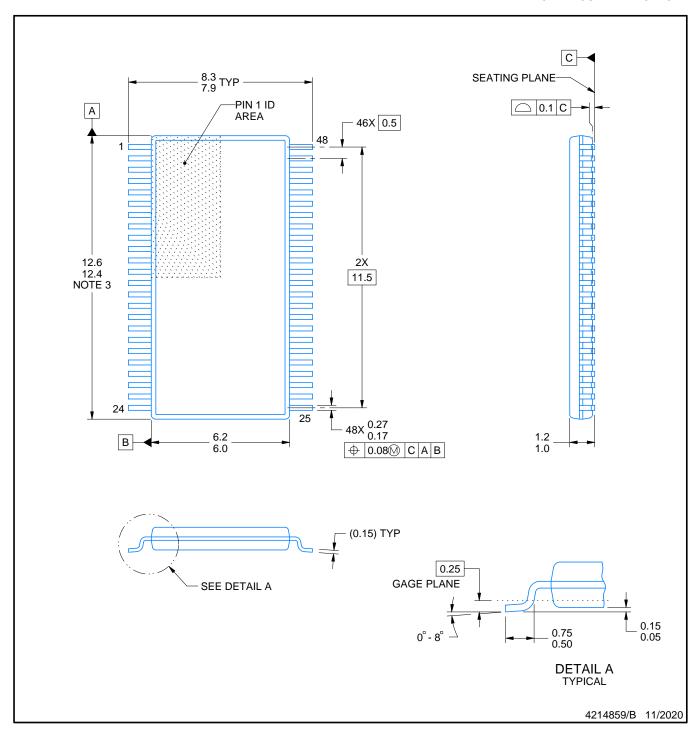
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.





SMALL OUTLINE PACKAGE



#### NOTES:

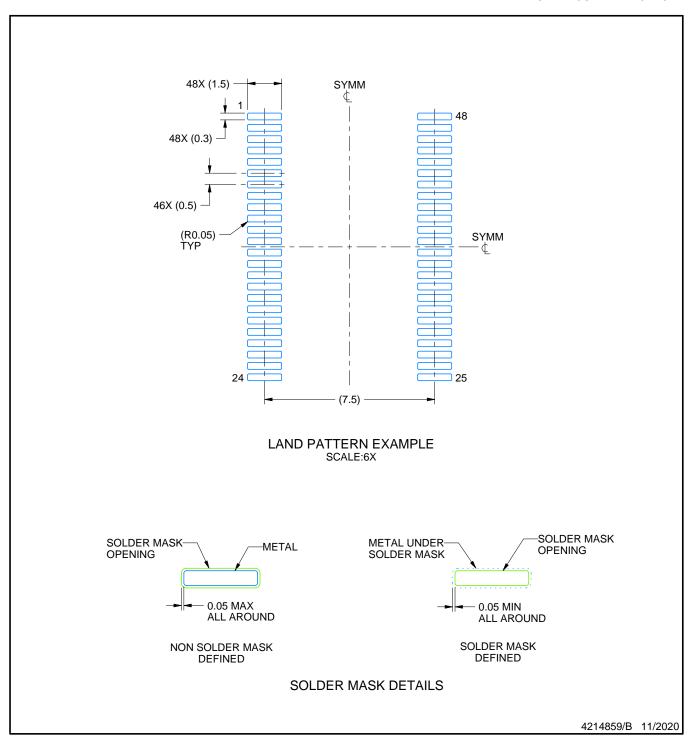
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE

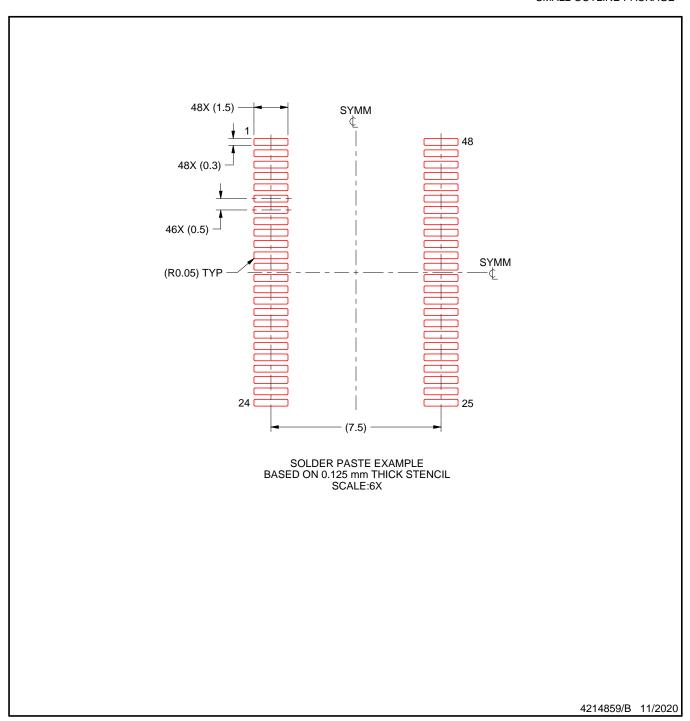


NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

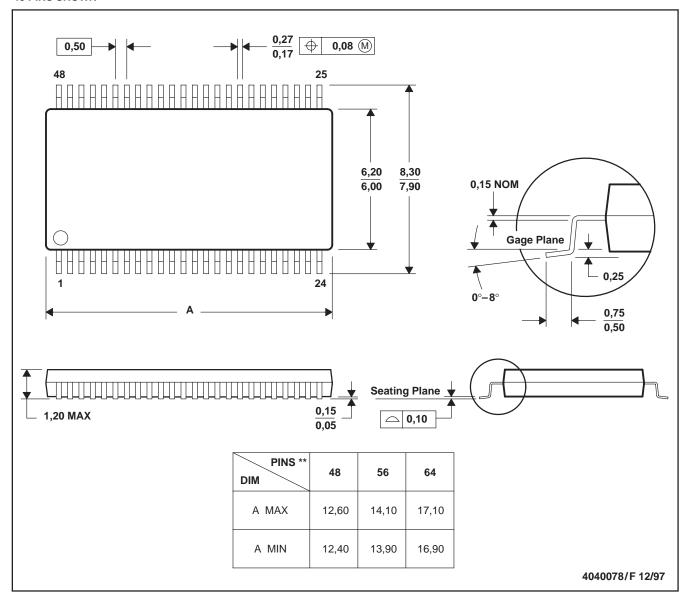
- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



#### DGG (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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